SPECIFICATIONS

CUSTOMER	: CRAFT
SAMPLE CODE (Ver.)	:
MASS PRODUCTION CODE (Ver.)	PC1602LRU-LWA-B-Q (Ver.A)
DRAWING NO. (Ver.)	: PC-95019(Ver.A)

Customer Approved

Date:

Approved	QC Confirmed	Designer
本于1950		-; 2 = 4 10/15-07

 $_{\square}$ Approval For Specifications Only.

Please contact Powertip or it's representative before designing your product based on this specification.

Approval For Specifications and Sample.

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(#07920B) NO.PT-A-005-6

^{*} This specification is subject to change without notice.



RECORDS OF REVISION

Date	Rev.	Description	Note	Page
2005/10/25	0	PC1602LRU-LWA-B-Q is the ROHS compliant part number based on Powertip's standard PC1602LRU-LWA-B		
2007/10/15	A	Update Timing Characteristics and Display Command		12,14

Total: 23 Page



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Note: For detailed information please refer to IC data sheet: ST7066U,



1. SPECIFICATIONS

1.1 Features

Item	Standard Value			
Display Type	16 * 2 characters			
LCD Type	STN,YG, Transflective ,Positive , Normal Temp.			
Driver Condition	LCD Module: 1/16 Duty · 1/4 Bias			
Viewing Direction	6 O'clock			
Backlight	YG LED B/L			
Weight	70.0g			
Interface	_			
Other	_			

1.2 Mechanical Specifications

Item	Standard Value		
Outline Dimension	122.0(L) * 44.0(w) * 14.0(H)(Max)	mm	
Viewing Area	99.0(L) * 24.0(w)	mm	
Active Area	94.84(L) * 20.0(w)	mm	
Dot Size	0.92(L) * 1.10(w)	mm	
Dot Pitch	0.98(L) * 1.16(w)	mm	

Note: For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	V_{DD}	_	-0.3	7.0	V
LCD Driver Supply Voltage	V_{LCD}	_	VDD-10.0	V _{DD} +0.3	V
Input Voltage	V_{IN}	_	-0.3	V _{DD} +0.3	V
Operating Temperature	T_{OP}	Excluded B/L	0	50	$^{\circ}\mathbb{C}$
Storage Temperature	T_{ST}	Excluded B/L	-20	70	$^{\circ}\!\mathbb{C}$
Storage Humidity	H_D	Ta < 40 °C	-	90	%RH



1.4 DC Electrical Characteristics

$V_{DD} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $Ta = 2$	25°C	25 ((
---	------	------	---

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	V_{DD}	_	4.5	5.0	5.5	V
"H" Input Voltage	V_{IH}	_	0.7 Vdd	-	V_{DD}	V
"L" Input Voltage	V _{IL}	_	-0.3	-	0.6	V
"H" Output Voltage	V_{OH}	IOH=-0.1mА	3.9	-	V_{DD}	V
"L" Output Voltage	V_{OL}	IOL=0.1mA	-	-	0.4	V
Supply Current	I_{DD}	$V_{DD} = 5.0 \text{ V}$	-	1.1	3.0	mA
		V_{DD} - V_{O} (0°C)	-	-	-	
LCM Driver Voltage	V_{OP}	V _{DD} - V _O (25°C)	4.2	4.4	4.6	V
		V_{DD} - V_{O} (50°C)	-	-	-	

1.5 Optical Characteristics

LCD Panel : 1/16 Duty , 1/4 Bias , V_{LCD} =4.4 V , $Ta=25\,^{\circ}\!\text{C}$

Item	Symbol	Conditions	Min.	Тур.	Max.	Reference
View Angle	θ	$C \ge 2.0, \varnothing = 0^{\circ}$	0°	-	40°	Notes 1 & 2
Contrast Ratio	С	$\theta = 5^{\circ}, \varnothing = 0^{\circ}$	5	7	-	Note 3
Response Time(rise)	tr	$\theta = 5^{\circ}, \varnothing = 0^{\circ}$	-	150 ms	-	Note 4
Response Time(fall)	tf	$\theta = 5^{\circ}, \varnothing = 0^{\circ}$	-	330 ms	-	Note 4



Note 1: Definition of angles θ and \emptyset

Light (when reflected) $z (\theta=0^{\circ})$

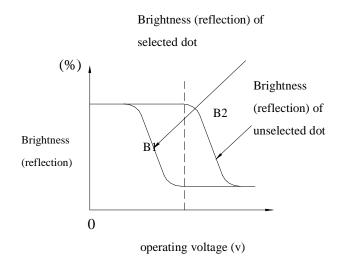
Sensor θ $Y'(\emptyset=180^\circ)$ X' Z' Z' Z' Z'

Light (when transmitted) $Y(\varnothing=0^{\circ})$ $(\theta=90^{\circ})$

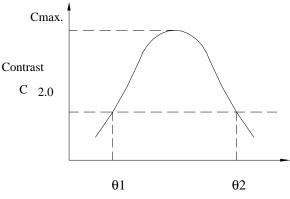
Note 3: Definition of contrast C

Brightness (reflection) of unselected dot (B2)

Brightness (reflection) of selected dot (B1)



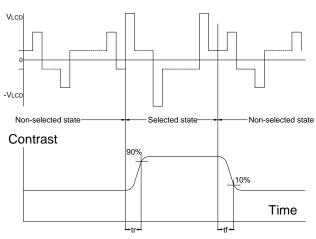
Note 2: Definition of viewing angles $\theta 1$ and $\theta 2$



viewing angle θ (\emptyset fixed)

Note : Optimum viewing angle with the $naked\ eye\ and\ viewing\ angle\ \theta\ at$ $Cmax.\ Above\ are\ not\ always\ the\ same$

Note 4: Definition of response time



Note: Measured with a transmissive LCD panel which is displayed 1 cm²

 V_{LCD} : Operating voltage F_{FRM} : Frame frequency t_r : Response time (rise) t_f : Response time (fall)

C = -



1.6 Backlight Characteristics

LCD Module with LED Backlight

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°℃	-	800	mA
Reverse Voltage	VR	Ta =25°℃	-	10	V
Power Dissipation	PO	Ta =25°C	-	3.68	W

Electrical / Optical Characteristics

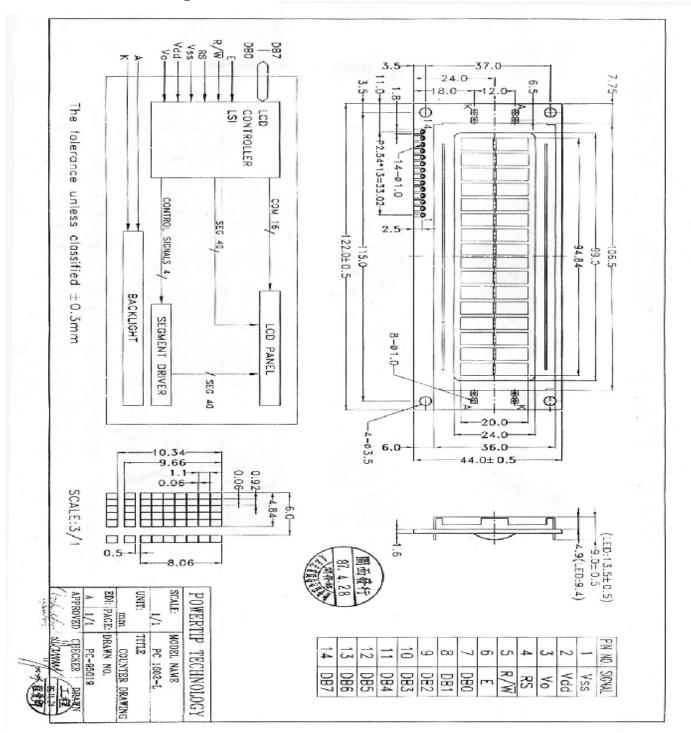
Ta =25°C

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF=240 mA	3.6	-	4.6	V
Reverse Current	IR	VR=-10V	-	-	0.32	mA
Wavelength	λр	IF=240 mA	569	-	576	nm
Luminous Intensity (without LCD)	IV	IF=240 mA	80	100		cd/m ²
Color	Yellow-green					



2. MODULE STRUCTURE

2.1 Counter Drawing

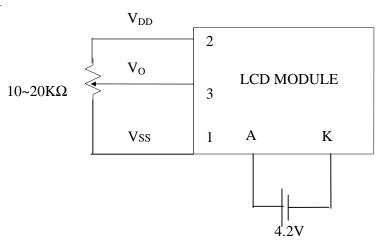




2.2 Interface Pin Description

Pin No.	Symbol	Signal Description
1	Vss	Power Supply (V _{SS} =0)
2	Vdd	Power Supply (V _{DD} >V _{SS})
3	Vo	Operating voltage for LCD (variable)
		Register Selection input
4	RS	High = Data register
4	KS	Low = Instruction register (for write)
		Busy flag address counter (for read)
		Read/Write signal input is used to select the read/write
5	R/\overline{W}	mode
		High = Read mode, Low = Write mode
6	Е	Start enable signal to read or write the data
		Four low order bi-directional three-state data bus lines. Use
7~10	DB0 ~ DB3	for data transfer between the MPU and the LCD module.
		These four are not used during 4-bit operation.
		Four high order bi-directional three-state data bus lines.
11~14	DB4 ~ DB7	Used for data transfer between the MPU and the LCD
		module.
		DB7 can be used as a busy flag.

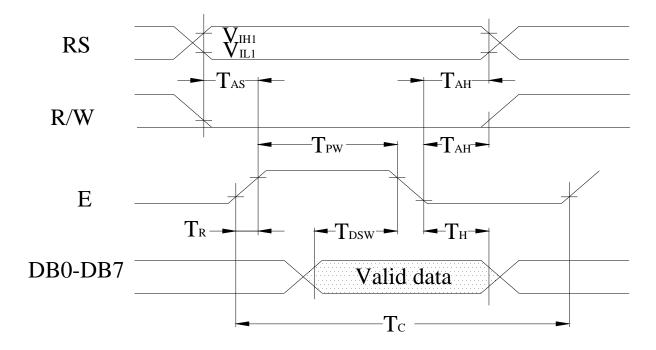
Contrast Adjust



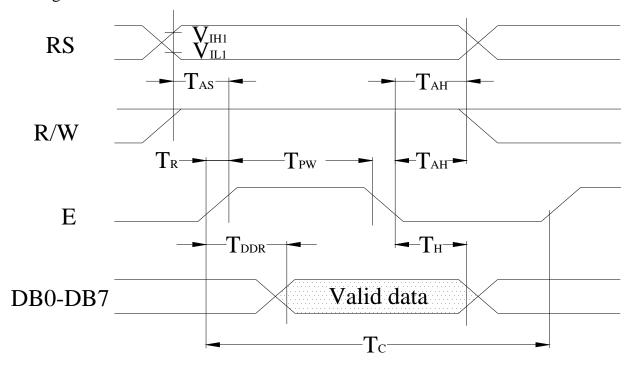


2.3 Timing Characteristics

• Writing data from MPU to ST7066U



•Reading data from ST7066U to MPU





• Write Mode (Writing data from MPU to ST7066U)

 $(Vcc = +5V,Ta=25^{\circ}C)$

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
$T_{\rm C}$	Enable Cycle Time	Pin E	1200	-	-	ns
T_{PW}	Enable Pulse Width	Pin E	140	-	-	ns
T_R, T_F	Enable Rise / Fall Time	Pin E	-	-	25	ns
T _{AS}	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
T_{AH}	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
T_{DSW}	Data Setup Time	Pins:DB0~DB7	40	-	-	ns
T _H	Data Hold Time	Pins:DB0~DB7	10	-	-	ns

• Read Mode (Reading data from ST7066U to MPU)

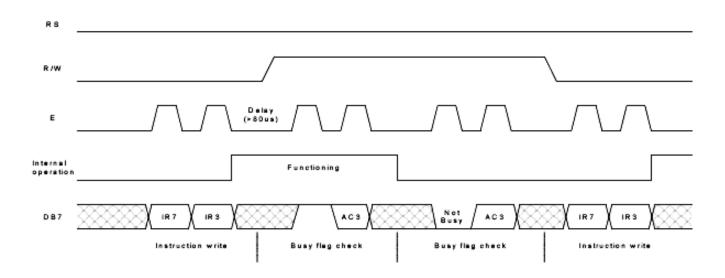
 $(Vcc = +5V,Ta=25^{\circ}C)$

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
$T_{\rm C}$	Enable Cycle Time	Pin E	1200	ı	1	ns
T_{PW}	Enable Pulse Width	Pin E	140	-	-	ns
T_R, T_F	Enable Rise / Fall Time	Pin E	-	-	25	ns
T _{AS}	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
T_{AH}	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
T_{DDR}	Data Setup Time	Pins:DB0~DB7	-	-	100	ns
T _H	Data Hold Time	Pins:DB0~DB7	10	-	-	ns



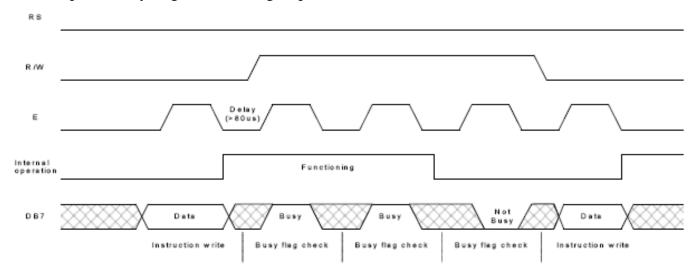
For 4-bit interface date, only four bus lines (DB4 to DB7) are used for transfer.

Example of busy flag check timing sequence



For 8-bit interface date, all eight bus lines (DB0 to DB7) are used .

Example of busy flag check timing sequence





2.4 Display Command

2.7 Dispi				iaiiu							T	
					Instru	iction	Code					Description
Instructions	RS	R/W	DB 7	DB 6	DB 5	DB 4	DB 3	DB 2	DB 1	DB 0	Description	Time (270KHz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC.	1.52ms
Return Home	0	0	0	0	0	0	0	0	1	×	Set DDRAM address to "00H" from AC and return cursor to it's original position if shifted. The contents of DDRAM are not changed.	1.52ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	37118
Display ON/OFF	0	0	0	0	0	0	1	D	С	В	D=1 : entire display on C=1 : cursor on B=1 : cursor position on	37µs
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	×	×	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	37µs
Function Set	0	0	0	0	1	DL	N	F	×	×	DL: interface data is 8/4 bits NL: number of line is 2/1 F: font size is 5×11/5×8	37µs
Set CGRAM Address	0	0	0	1	AC 5	AC 4	AC 3	AC 2	AC 1	AC 0	Set CGRAM address in address counter.	37µs
Set DDRAM Address	0	0	1	AC 6	AC 5	AC 4	AC 3	AC 2	AC 1	AC 0	Set DDRAM address in address counter.	37µs



Read Busy Flag and Address	0	1	BF	AC 6	AC 5	AC 4	AC 3	AC 2	AC 1	AC 0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0μs
Write Data	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM	37µs
to RAM	-		υ,	В		D.		D2		D0	(DDRAM/CGRAM).	37μ5
Read Data	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM	37us
from RAM	1	1	וע	טט	D5	D4	טט	D2	וטו	טט	(DDRAM/CGRAM).	37μ8

Note:

Be sure the ST7066U is not in the busy state (BF=0) before sending an instruction from the MPU to the ST7066.

If an instruction is sent without checking the busy flag , the time between the first instruction and next instruction will take much longer than the instruction time itself.

Before checking BF, be sure to wait at least 80us.. Do not keep "E" always "High" for checking BF. Refer to Instruction Table for the list of each instruction execution time.



2.5 Character Pattern

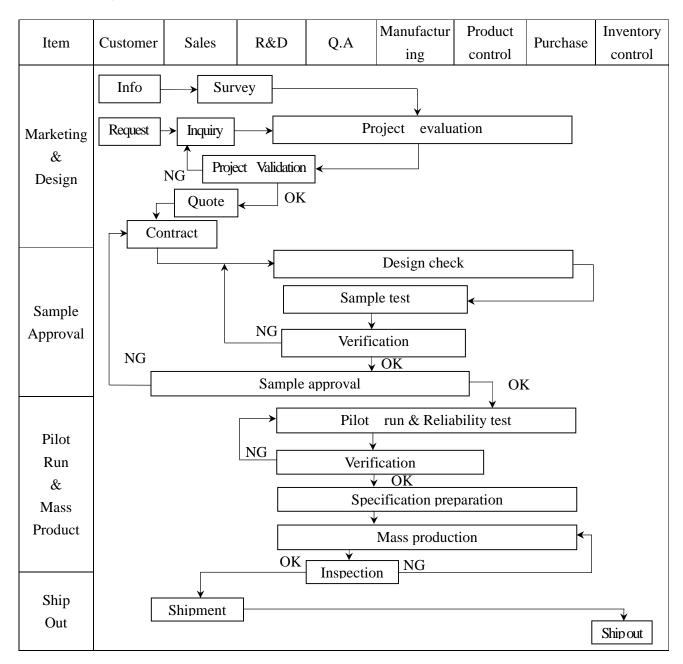
■ CHARACTER PATTERN(SO/HO/EA,WA)

Lower 4 Bits	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
xxxx0000	CG RAM (1)						·	 -					-53	≡ .		
xxxx0001	(2)		I	1			-===	-===			===	<u> </u>	===	<u></u> :	-	
xxxx0010	(3)		11			F	<u></u>	 -			I		! <u>!</u> .!	_::: ¹		
xxxx0011	(4)		#			===	≡	:≣-			!	" ;]	-37-	===	==:-	::-::
××××0100	(5)		#	∴ ‡.		T	-::	† <u>.</u> .					ŀ	1	<u> </u>	===
xxxx0101	(6)		 <u></u>			II	====	II			==	r	<u>-</u>			
xxxx0110	(7)			<u>::</u> .		l .l	₽	II			====]]		===	; :::	<u>:</u> :::
xxxx0111	(8)		:=			إبيا	-==	l <u>.</u> ı,l				=	.:: :			FE
xxxx1000	(1)		!			; =;	! ;]:-: <u>]</u>				-::]	:#:	<u>.</u> .!	I	3=0
xxx1001	(2)		<u>:</u>	-	I	' '	i					. 'T	ا.	ı L.	:	<u></u>
xxxx1010	(3)		:-[-:	#	[<u>.::</u>	:	.:: :					·		j	==:
xxxx1011	(4)		[:	! ::		-:				:= ! -	<u> </u>	!		:•:]=
xxxx1100	(5)		:=	-:		4	1	I			1-:-	::!	- <u></u> _		:: -	
xxxx1101	(6)						[** <u> </u>	} -			.::.	=:	٠٠.	 	#	
xxxx1110	(7)		==	<u>:</u> :-		<u>-</u>	F								F=1	
xxxx1111	(8)			-				-:				·	:	EE .		

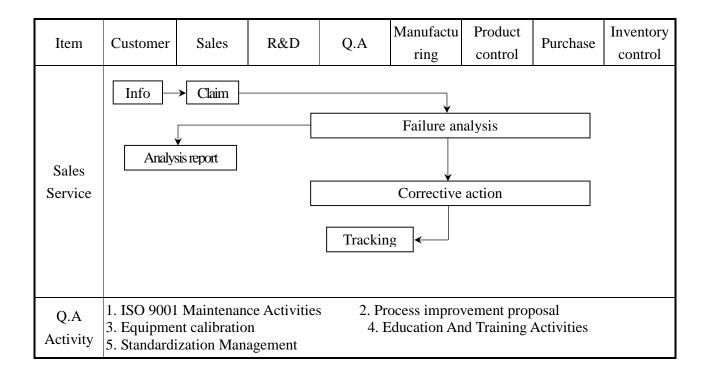


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



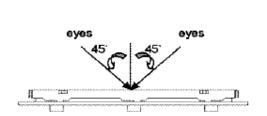


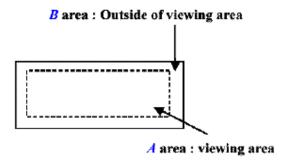




3.2 Inspection Specification

- ◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample
- ◆Defect Level: Major Defect AQL 0.4; Minor Defect AQL 1.5.
- ♦OUT Going Defect Level: Sampling.
- ◆Manner of appearance test :
 - (1). The test be under 40W×2 fluorescent light 'and distance of view must be at 30 cm.
 - (2). The test direction is base on about around 45° of vertical line. (Fig. 1)
 - (3). Definition of area . (Fig. 2)





◆ Specification:

NO	Item	Criterion	level
		1.1 The part number is inconsistent with work order of Production.	Major
01	Product condition	1.2 Mixed production types.	Major
		1.3 Assembled in inverse direction.	Major
02	Quantity	2.1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major
		4.1 Missing line character \ dot and icon.	Major
		4.2 No function or no display.	Major
04	Electrical Testing	4.3 Output data is error.	Major
		4.4 LCD viewing angle defect.	Major
		4.5 Current consumption exceeds product specifications.	Major
05	Black or white dot \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	 5.1 Round type: 5.1.1 display only: • White and black spots on display ≤ 0.25mm, no more than Four white or black spots present. • Densely spaced: NO more than two spots or lines within 3mm 	Minor



◆Specification:

NO	Item	Criterion	Criterion						level
NO 05	Black or white dot scratch contamination Round type $\Phi = (x+y)/2$	5.1.2 Nom-o Din 0.1 0.2 5.1.3 Line ty	w≤0.03mm			Acceptance (Q'ty) Accept no dense 3 2 4 Acceptance (Q'ty) A area B area Accept no dense Don't count Don't count			
	→ L W	L≦3.0mm L≦2.5mm	$0.03 \text{mm} < \Phi \le 0$ $0.05 \text{mm} < \Phi \le 0$ 0.075 mm	.075mm	4 As round		Don't co		
06	Polarizer Bubble		(diameter : Φ)	Acc	Acceptance(Q'ty) A area B area ccept no dense Don't count 3 Don't count 2 Don't count 0 Don't count 4 Don't count				Minor
07	The crack of glass						Minor		



◆Specification:

	ecification:				
NO	Item	Criterion			Level
		Glass Crack:7.2 General glass cra7.2.1	ck and corner edge:	Z	
	The crack of glass	X	Y	Z	Minor
	X: The length of Crack	Neglect	Out A area	Neglect	
	Y: The width of crack	7.2,2			
07	Z: The thickness of crack		X		
	D: terminal length	X	Y Out A area	Z	
	T: The thickness of glass	Neglect	Out A area	Neglect	
	A: The length of glass	7.3 Glass remain:			
				Y 1/3 d	Minor



◆Specification:

	ecification:	I					
NO	Item	Criterion			Level		
07	The crack of glass X: The length of Crack Y: The width of crack Z: The thickness of crack D: terminal length T: The thickness of	7.4 Corner cra	ack and medial crack:	X X SP	Minor		
	glass	X	Y	Z			
	A: The length of	≤1/5a	Crack can't enter viewing area	≤1/2t			
	glass	≤1/5a	Crack can't exceed the half of width of SP width of SP	$1/2t < Z \le 2t$			
		8.1 Backlight c	an't work normally.		Major		
08	Backlight elements	8.2 Backlight doesn't light or color is wrong.					
08	cicinents	8.3 Illumination source flickers when lit.					
		9.1 pin type mu	ast match type in specification shee	et	Major		
		9.2 No short circuits in components on PCB or FPC					
09	General appearance	9.3Product packaging must the same as specified on packaging specification sheet.					
		9.4 The folding and peeled off in polarizer are not acceptable					
			or FPC between B/L assembled divergence PC is ≤ 1.5 mm	istance	Major		
		I			1		



4. RELIABILITY TEST

4.1 Reliability Test Condition

	Test Condition						
NO.	TEST ITEM	TEST CONDITION					
1	High Temperature Storage Test	Keep in 70 $\pm 2^{\circ}$ C 96 hrs					
		Surrounding temperature, then storage	ge at normal condition 4hrs				
2	Low Temperature Storage Test	Keep in -20 $\pm 2^{\circ}$ C 96 hrs					
		Surrounding temperature, then storage					
		Keep in $+60^{\circ}$ C/90%RH duration for					
		Surrounding temperature, then storage	ge at normal condition 4hrs				
3	High Hymidity Storage	(Excluding the polarizer)Or					
3	High Humidity Storage	Keep in $+40^{\circ}$ C/90%RH duration for					
		Surrounding temperature, then storage at normal condition 4hrs					
4	Vibration Test	1. Sine wave $10 \sim 55$ HZ frequency	(1 min)				
4	Vibration Test	2. The amplitude of vibration :1.5 i	mm				
		3. Each direction (XYZ) duration f	for 2 Hrs				
		Air Discharge:	Contact Discharge:				
		Apply 6 KV with 5 times	Apply 250V with 5 times				
		Discharge foreach polarity +/-	discharge foreach polarity +/-				
		1. Temperature ambinace:15°C ~35°C					
		2. Humidity relative: $30\% \sim 60\%$					
5	ESD Test	3. Energy Storage Capacitance(Cs+Cd):150pF±10%					
		4. Discharge Resistance(Rd):330 Ω±10%					
		5. Discharge, mode of operation:					
		Single Discharge (time between succ	<u> </u>				
		(Tolerance If the output voltage indic					
		$-20^{\circ}\text{C} \rightarrow 25^{\circ}\text{C} \rightarrow 70^{\circ}\text{C}$	$C \rightarrow 25^{\circ}C$				
6	Tomas anothers Cycling Toot	(30mins) (5mins) (3	30mins) (5mins)				
6	Temperature Cycling Test	(30mins) (5mins) (5mins) 10 Cycle					
		Surrounding temperature, then storage at normal condition 4hrs					
		1. Sine wave 10~55HZ frequency					
7	Vibration Test (Packaged)						
		2. The amplitude of vibration :1.5 mm3. Each direction (XYZ) duration for 2 Hrs					
		Packing Weight (Kg)	Drop Height (cm)				
		0 ~ 45.4	122				
		45.4 ~ 90.8	76				
8	Drop Test (Packaged)	90.8 ~ 454	61				
		Over 454	46				
		D 11 11 11/2					
		Drop direction: ×3 comer	/1 edges /6 sides etch 1times				



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period
 - The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment , we cannot take responsibility if the product is used in nuclear power control equipment , aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.